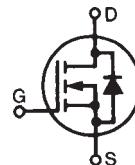


**Polar™**  
**Power MOSFET**

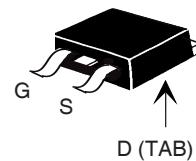
**IXTA06N120P**  
**IXTP06N120P**

**V<sub>DSS</sub>** = 1200V  
**I<sub>D25</sub>** = 0.6A  
**R<sub>DS(on)</sub>** ≤ 34Ω

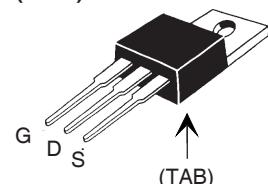
N-Channel Enhancement Mode  
Avalanche Rated



TO-263 (IXTA)



TO-220 (IXTP)



G = Gate      D = Drain  
 S = Source      TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>j</sub> = 25°C to 150°C	1200		V
V <sub>DGR</sub>	T <sub>j</sub> = 25°C to 150°C, R <sub>GS</sub> = 1MΩ	1200		V
V <sub>GSS</sub>	Continuous	±20		V
V <sub>GSM</sub>	Transient	±30		V
I <sub>D25</sub>	T <sub>c</sub> = 25°C	0.6		A
I <sub>DM</sub>	T <sub>c</sub> = 25°C, Pulse Width Limited by T <sub>JM</sub>	1.2		A
I <sub>A</sub>	T <sub>c</sub> = 25°C	0.6		A
E <sub>AS</sub>	T <sub>c</sub> = 25°C	50		mJ
dV/dt	I <sub>S</sub> ≤ I <sub>DM</sub> , V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>j</sub> ≤ 150°C	10		V/ns
P <sub>D</sub>	T <sub>c</sub> = 25°C	42		W
T <sub>j</sub>		-55 ... +150		°C
T <sub>JM</sub>		150		°C
T <sub>stg</sub>		-55 ... +150		°C
T <sub>L</sub>	1.6mm (0.062) from Case for 10s	300		°C
T <sub>SOLD</sub>	Plastic Body for 10s	260		°C
M <sub>d</sub>	Mounting Torque (TO-220)	1.13 / 10		Nm/lb.in.
Weight	TO-263	2.5		g
	TO-220	3.0		g

Symbol	Test Conditions (T <sub>j</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	1200		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 50μA	2.0		4.0 V
I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±50 nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V T <sub>j</sub> = 125°C			3 μA 125 μA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> , Note 1	27	34	Ω

### Features

- International Standard Packages
- Avalanche Rated
- Low Package Inductance

### Advantages

- Easy to Mount
- Space Savings
- High Power Density

### Applications

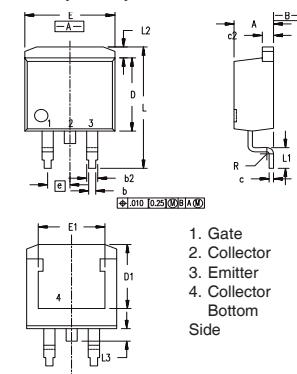
- High Voltage Switched-Mode and Resonant-Mode Power Supplies
- High Voltage Pulse Power Applications
- High Voltage Discharge Circuits in Lasers Pulsers, Spark Igniters, RF Generators
- High Voltage DC-DC Converters
- High Voltage DC-AC Inverters

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
<b>g<sub>fs</sub></b>	V <sub>DS</sub> = 30V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> , Note 1	0.28	0.45	S
<b>C<sub>iss</sub></b> <b>C<sub>oss</sub></b> <b>C<sub>rss</sub></b>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz	236 15 3.2		pF pF pF
<b>t<sub>d(on)</sub></b> <b>t<sub>r</sub></b> <b>t<sub>d(off)</sub></b> <b>t<sub>f</sub></b>	<b>Resistive Switching Times</b> V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 0.5 • I <sub>D25</sub> , R <sub>G</sub> = 50Ω (External)	19 37 35 34		ns ns ns ns
<b>Q<sub>g(on)</sub></b> <b>Q<sub>gs</sub></b> <b>Q<sub>gd</sub></b>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 0.5 • I <sub>D25</sub>	13.3 2.4 7.8		nC nC nC
<b>R<sub>thJC</sub></b> <b>R<sub>thCS</sub></b>	(TO-220)	0.50	3.0 °C/W °C/W	

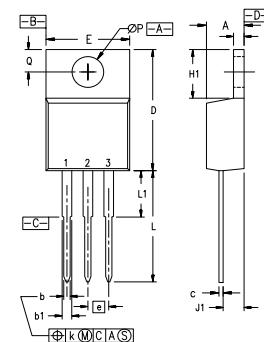
### Source-Drain Diode

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I <sub>s</sub>	V <sub>GS</sub> = 0V		0.6 A	
I <sub>sm</sub>	Repetitive, Pulse Width Limited by T <sub>JM</sub>		1.8 A	
V <sub>SD</sub>	I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0V, Note 1		1.5 V	
t <sub>rr</sub>	I <sub>F</sub> = 0.6A, -di/dt = 100A/μs V <sub>R</sub> = 100V, V <sub>GS</sub> = 0V	900		ns

Note 1. Pulse test, t ≤ 300 μs; duty cycle, d ≤ 2%.

**TO-263 (IXTA) Outline**


Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.06	4.83	.160	.190
b	0.51	0.99	.020	.039
b2	1.14	1.40	.045	.055
c	0.40	0.74	.016	.029
c2	1.14	1.40	.045	.055
D	8.64	9.65	.340	.380
D1	8.00	8.89	.312	.320
E	9.65	10.41	.380	.405
E1	6.22	8.13	.270	.320
e	2.54	BSC	.100	BSC
L	14.61	15.88	.575	.625
L1	2.29	2.79	.090	.110
L2	1.02	1.40	.040	.055
L3	1.27	1.78	.050	.070
L4	0	0.13	0	.005

**TO-220 (IXTP) Outline**


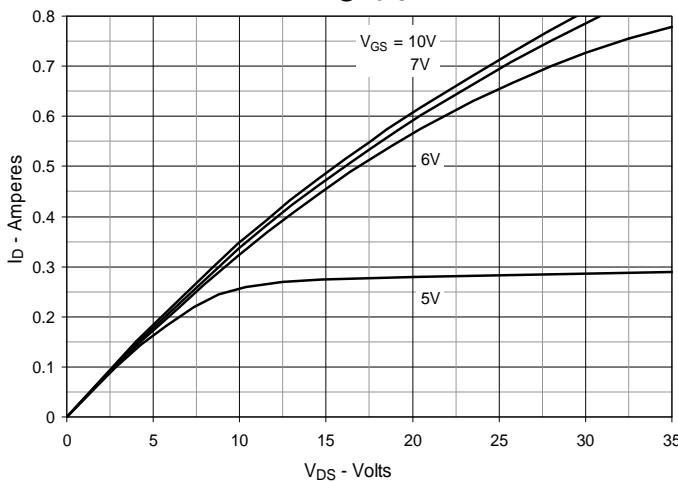
Pins: 1 - Gate      2 - Drain

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
c	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
e	.100 BSC		2.54 BSC	
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
K	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
ØP	.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

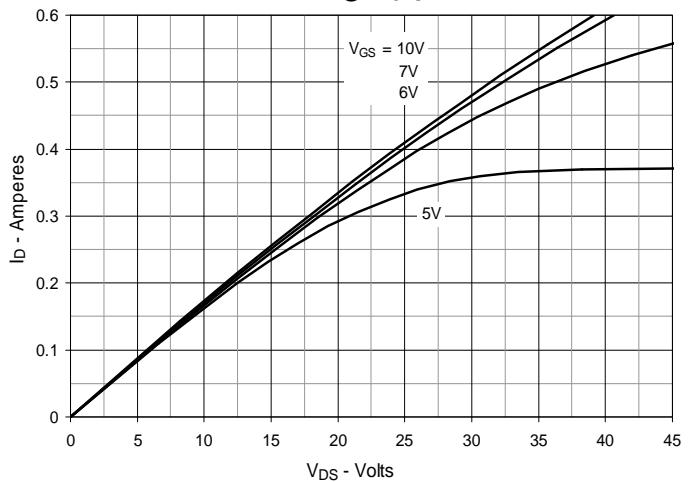
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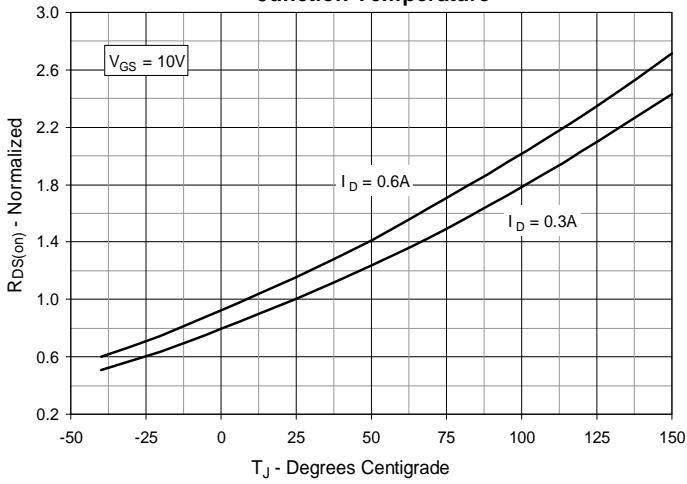
**Fig. 1. Output Characteristics  
@ 25°C**



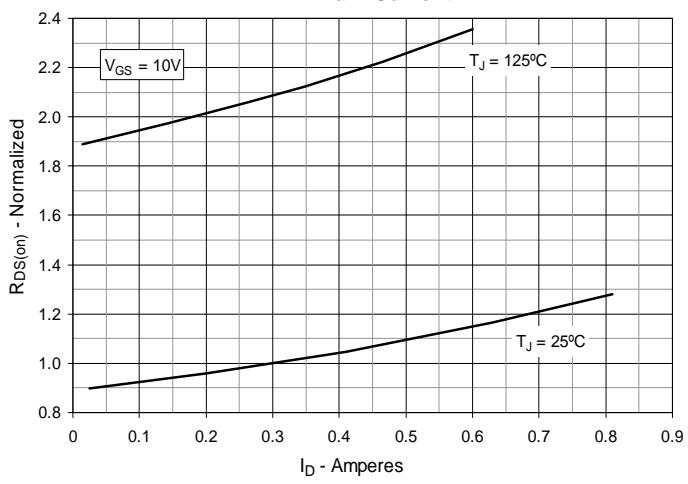
**Fig. 2. Output Characteristics  
@ 125°C**



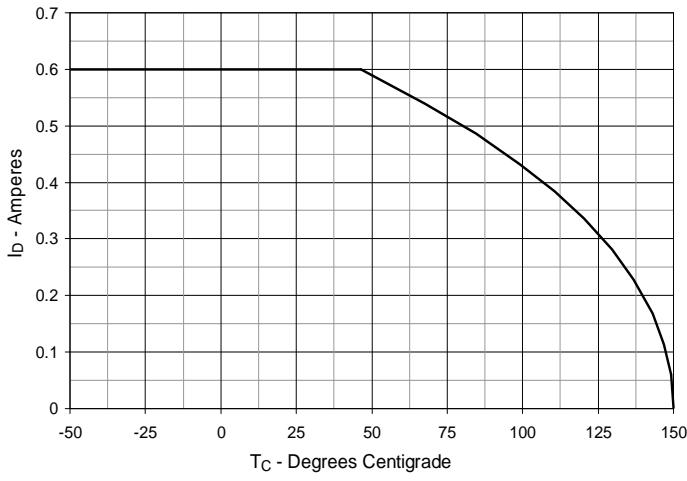
**Fig. 3.  $R_{DS(on)}$  Normalized to  $I_D = 0.3A$  Value vs.  
Junction Temperature**



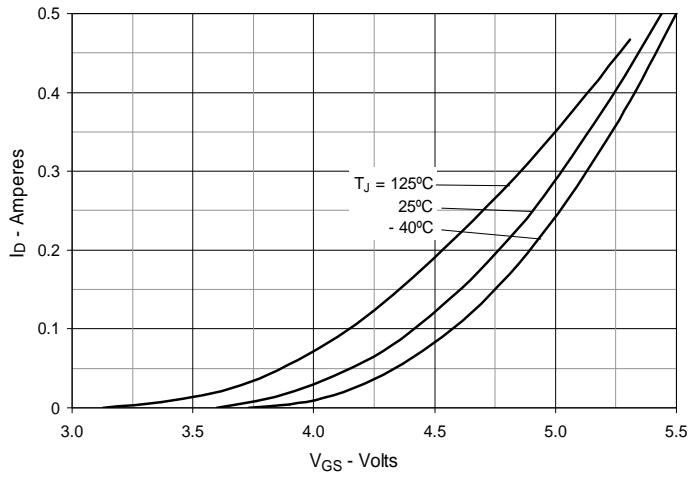
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 0.3A$  Value vs.  
Drain Current**

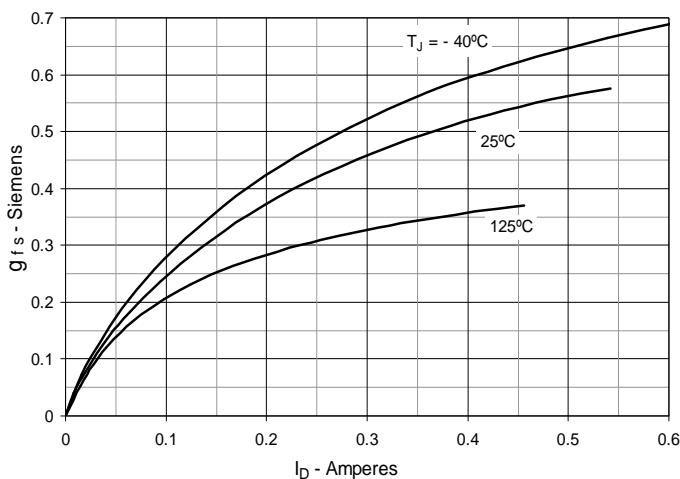
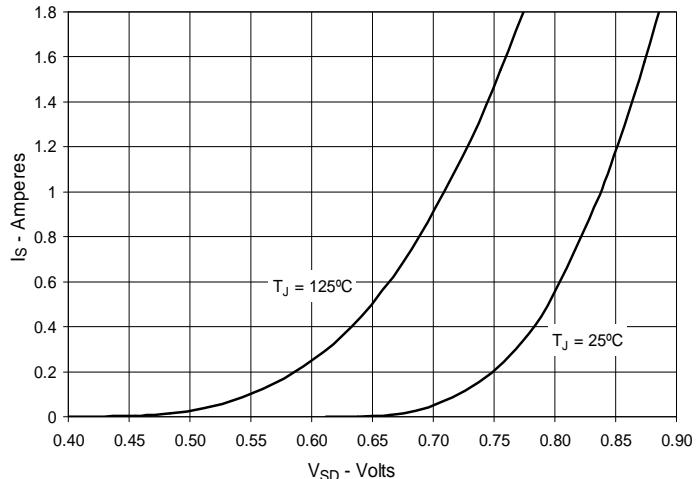
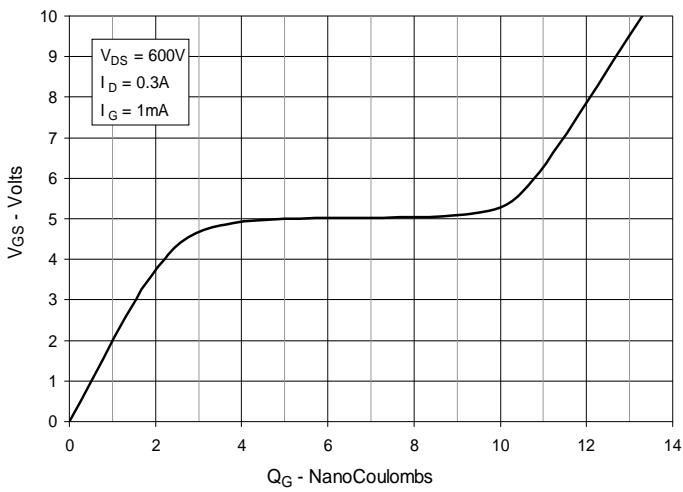
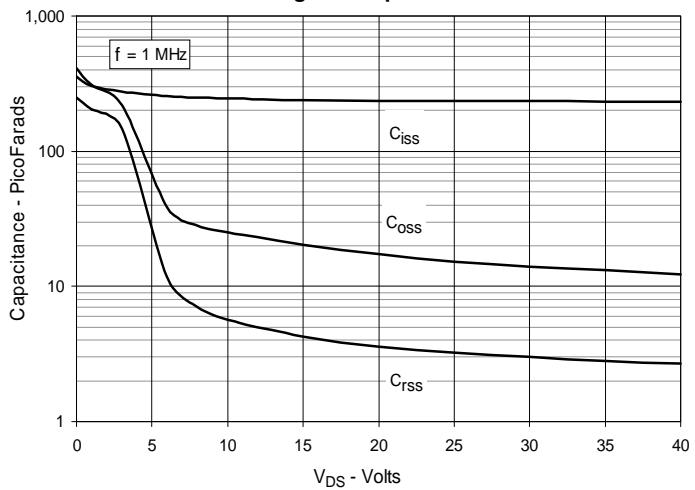
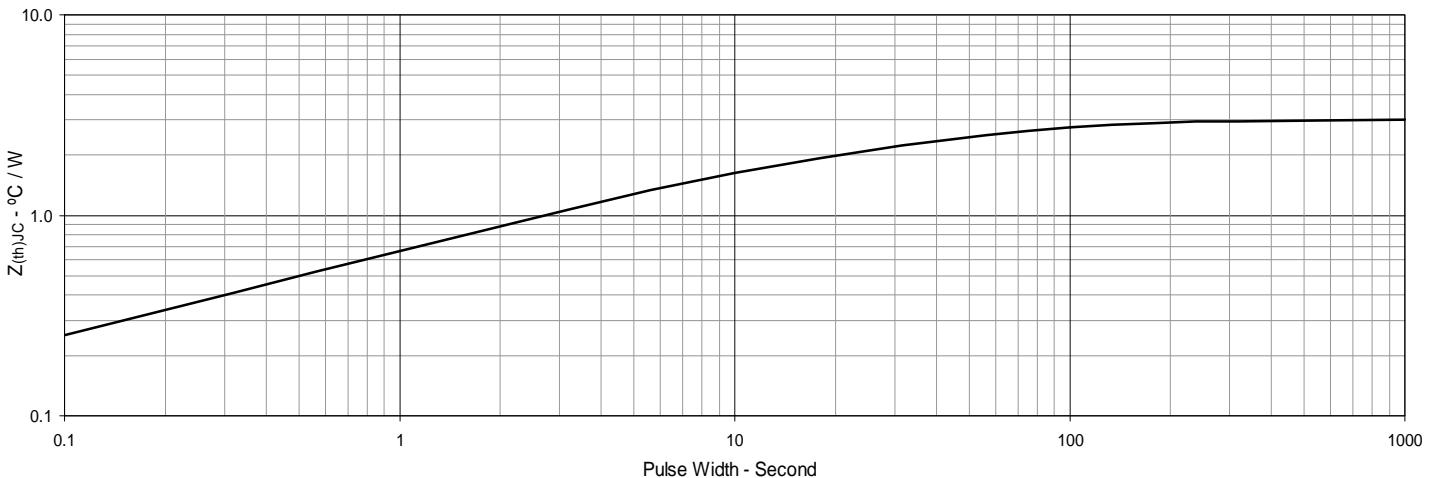


**Fig. 5. Maximum Drain Current vs.  
Case Temperature**



**Fig. 6. Input Admittance**



**Fig. 7. Transconductance**

**Fig. 8. Forward Voltage Drop of Intrinsic Diode**

**Fig. 9. Gate Charge**

**Fig. 10. Capacitance**

**Fig. 11. Maximum Transient Thermal Impedance**


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